

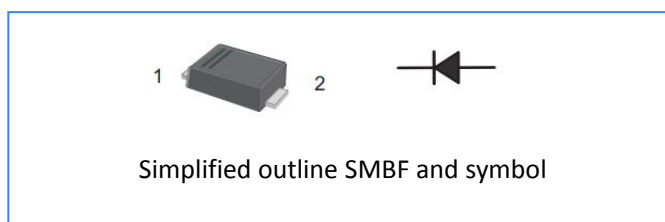
## US5ABF THRU US5MBF

### Features

- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Easy to pick and place
- High efficiency
- Lead free in comply with EU RoHS 2011/65/EU directives

### Mechanical Data

- Case:SMBF
- Terminals: Solderable per MIL-STD-750, Method 20
- Approx. Weight: 57mg / 0.002oz



### Pinning

PIN	DESCRIPTION
1	Cathode
2	Anode

### Absolute Maximum Ratings And Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Parameter	Symbols	US5ABF	US5BBF	US5DBF	US5GBF	US5JBF	US5KBF	US5MBF	Units
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Maximum RMS voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	$V_{DC}$	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current at $T_c = 125^\circ\text{C}$	$I_{F(AV)}$	5							A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load	$I_{FSM}$	150							A
Maximum Instantaneous Forward Voltage at 1 A	$V_F$	1.0			1.3	1.65			V
Maximum DC Reverse Current $T_a = 25^\circ\text{C}$ at Rated DC Blocking Voltage $T_a = 125^\circ\text{C}$	$I_R$	10 100							$\mu\text{A}$
Maximum Reverse Recovery Time <sup>(1)</sup>	$t_{rr}$	50				75			ns
Typical Thermal Resistance <sup>(2)</sup>	$R_{\theta JA}$	40							$^\circ\text{C/W}$
	$R_{\theta JC}$	12							
Operating and Storage Temperature Range	$T_j, T_{stg}$	-55 ~ +150							$^\circ\text{C}$

(1) Measured with  $I_F = 0.5\text{ A}$ ,  $I_R = 1\text{ A}$ ,  $I_{rr} = 0.25\text{ A}$

(2) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas

Rating And Characteristic Curves

Fig.1 Maximum Average Forward Current Rating

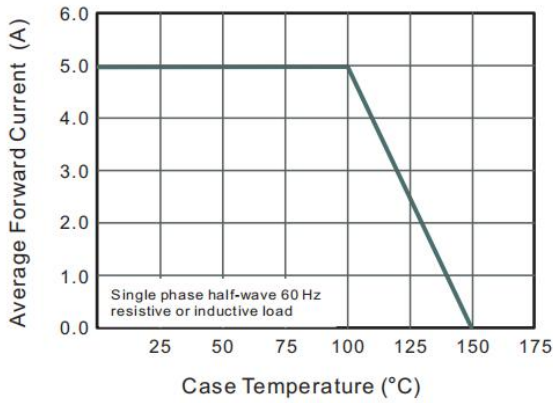


Fig.2 Typical Reverse Characteristics

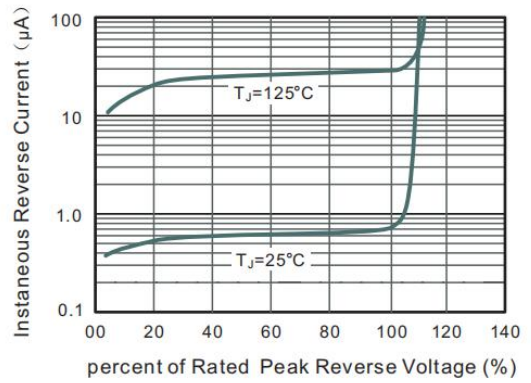


Fig.3 Typical Forward Characteristics

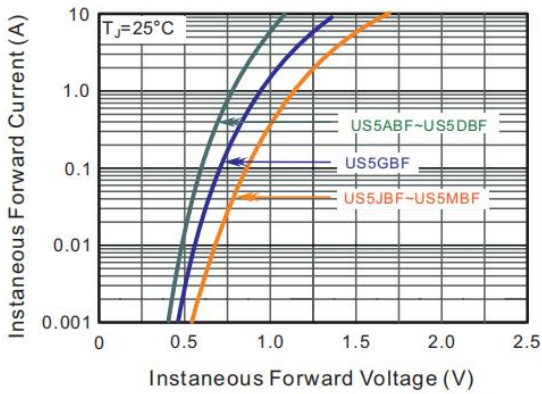
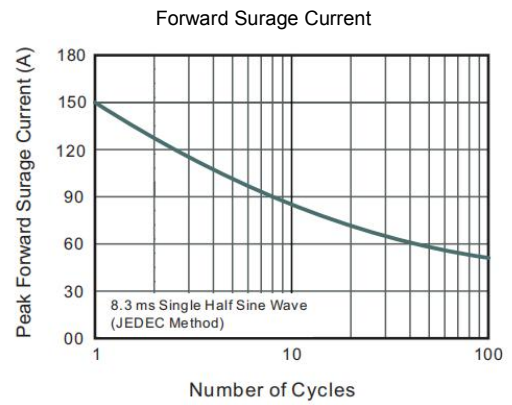


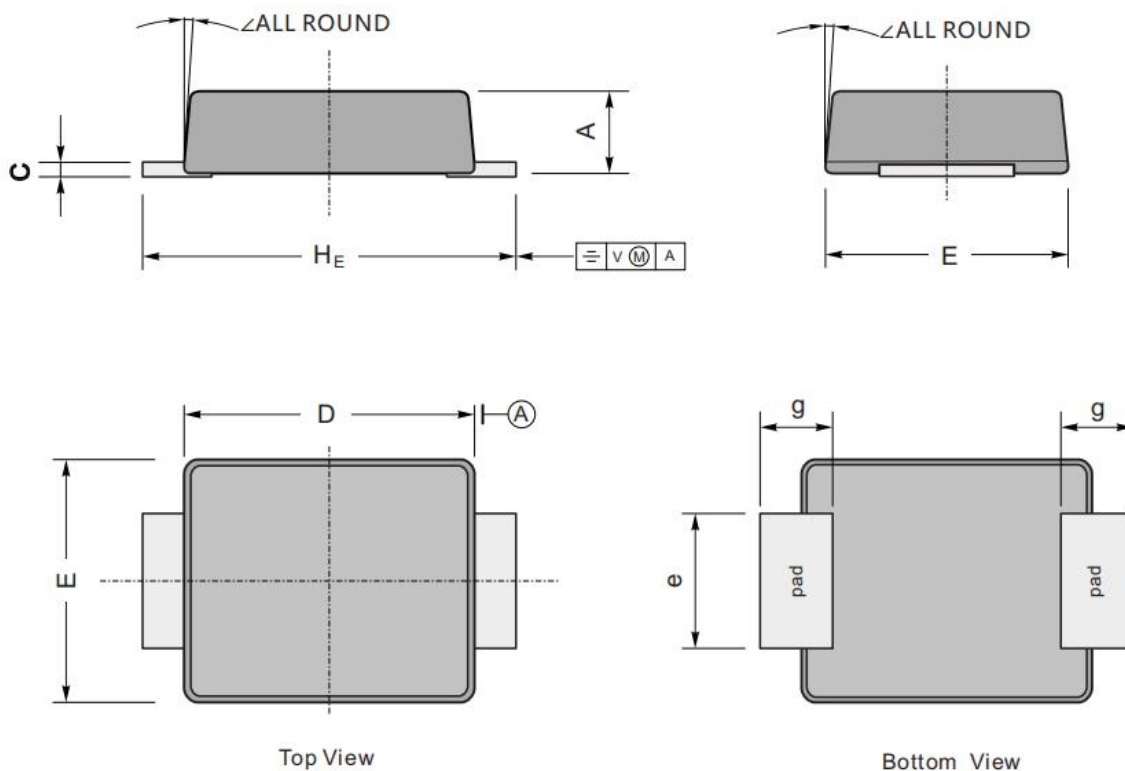
Fig.4 Maximum Non-Repetitive Peak Forward Surge Current



Package Outline

Plastic surface mounted package; 2 leads

SMBF



UNIT		A	C	D	E	e	HE	g	∠
mm	max	1.3	0.26	4.4	3.7	2.2	5.5	1.0	9°
	min	1.1	0.18	4.2	3.5	1.9	5.1		
mil	max	51	10	173	146	86	216	40	
	min	43	7	165	138	75	200		

The recommended mounting pad size

